Product-Env-Stewards       Product Enviro Compliance       NA       Product-Env-Stewards@onsemi.com         Authorized Representative*       Title - Representative       Phone - Representative*       Email - Representative*         Product-Env-Stewards       Product Enviro Compliance       NA       Product-Env-Stewards@onsemi.com         Requester Item Number       Mfr Item Number       Mfr Item Name       Effective Date       Version       Manufacturing Site       Weight*       UOM       U	IPC  ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
Company name*  Company unique ID  Unique ID Authority  Response Date*  2023-06-08  Contact Name  Title - Contact  Phone - Contact*  Phone - Contact*  Phone - Contact*  Product-Env-Stewards  Product Enviro Compliance  NA  Product-Env-Stewards	752-21.1											als and Mf	g Informati	ion	
Insemi In	upplier Informa	ntion						·							
Title - Contact Name Product-Env-Stewards Product-	Company name*	Company unique ID			J	Unique ID Authority				Response Date*					
Product-Env-Stewards Authorized Representative* Title - Representative Product Enviro Compliance NA Product Env-Stewards@onsemi.com Na Product-Env-Stewards@onsemi.com Na	nsemi											2023-06-08			
Authorized Representative*  Product-Env-Stewards Product Enviro Compliance Requester Item Number Requester Item Number NCP305LSQ24T1G NCP305LSQ24T1G ANA UNDERVOLT DETECT 2.4V Product-Env-Stewards NA Requester Item Number NCP305LSQ24T1G ANA UNDERVOLT DETECT 2.4V Product-Env-Stewards NCP305LSQ24T1G ANA UNDERVOLT DETECT 2.4V Requester Item Number NCP305LSQ24T1G ANA UNDERVOLT DETECT 2.4V Requester Item Number NCP305LSQ24T1G ANA UNDERVOLT DETECT 2.4V Requester Item Number Requester Item Number NCP305LSQ24T1G ANA UNDERVOLT DETECT 2.4V Requester Item Number Requester Item Number Requester Item Number Ncript Date Ncrip	Contact Name			Title - Contact			I	Phone - Contact*				Email - Contact*			
Product Envi-Stewards  Requester Item Number  Mfr Item Number  Mfr Item Number  Mfr Item Name  Effective Date  Version  Manufacturing Site  Weight*  UOM  U  ANA UNDERVOLT DETECT 2.4V  2023-06-08  MY1  7.22  mg  Effective Date  Weight*  Womber of Reflow Cycles  Matte Tin (Sn) - annealed  CU Alloy  1  260  C  30  Seconds  3	Product-Env-Stewar	ds		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM UNCP305LSQ24T1G ANA UNDERVOLT DETECT 2.4V 2023-06-08 MY1 7.22 mg E  Manufacturing Proccess Information  Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles Seconds 3  Matte Tin (Sn) - annealed CU Alloy 1 260 C 30 seconds 3	uthorized Represen	tative*		Title - Representative			I	Phone - Representative*				Email - Representative*			
Manufacturing Proccess Information  Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Matte Tin (Sn) - annealed CU Alloy 1 260 C 30 seconds 3	Product-Env-Stewar	ds		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Manufacturing Process Information  Terminal Plating / Grid Array Material  Terminal Base Alloy  J-STD-020 MSL Rating  Peak Process Body Temperature  Max Time at Peak Temperature  Number of Reflow Cycles  Matte Tin (Sn) - annealed  Comments	Requester	Requester Item Number Mfr Ite		em Number Mfr Item Name				Effective Date	Version	N	Manufacturing Site	W	eight*	UOM	Unit Type
Terminal Plating / Grid Array Material  Terminal Base Alloy  J-STD-020 MSL Rating  Peak Process Body Temperature  Max Time at Peak Temperature  Number of Reflow Cycles  260  Cu Alloy  Comments			NCP305LSQ24T1G ANA UNDERVOLT		LT DETECT 2	.4V	2023-06-08		MY1		7.	22	mg	Each	
Matte Tin (Sn) - annealed CU Alloy 1 260 C 30 seconds 3 comments				rminal Dags	Alloy	STD 020 MS1	Dating	Dook Pros	ans Dady T	Commorative	May Time at Peak	Tamparatu	ro Numb	per of Poflow Cyr	Jac
omments	2 2			·		S I D-020 MSL	_ Kaung						ber of Reflow Cyc	ries	
	•	(Sn) - annealed	C	) Alloy	I			200		<u> </u> C	30	second	8 3		
ver 1 - maximum time at peak temperature during soldering is 10-50 seconds		no of neals townsurf	luuina aal-l	lanina ia 10-2	O seconds										
or more information regarding material composition please refer to page 3															

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.13	mg	Supplier	Silicon (Si)	7440-21-3		0.13	mg
Die Attach	0.08		Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.0256	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.0534	mg
			В	Antimony Pentoxide (Sb2O5)	1314-60-9		0.001	mg
Lead Frame	1.31	mg	Supplier	Zinc (Zn)	7440-66-6		0.0013	mg
			Supplier	Iron (Fe)	7439-89-6		0.0301	mg
			Supplier	Copper (Cu)	7440-50-8		1.2772	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0013	mg
Mold Compound-Black	4.49	mg		Epoxy resin	proprietary data		0.211	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.449	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0045	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.6144	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.211	mg
Plating	1.19	mg	Supplier	Tin (Sn)	7440-31-5		1.19	mg
Wire Bond - Au	0.02	mg	Supplier	Gold (Au)	7440-57-5	_	0.02	mg